

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of :
Kazumi MATSUSHIGE et al. :
Serial No. NEW : **Attn: APPLICATION BRANCH**
Filed January 20, 2004 : Attorney Docket No. 2004-0076

METHOD OF SOLDERING LEAD-FREE
SOLDER, AND JOINED OBJECT
SOLDERED BY THE SOLDERING METHOD
(Rule 1.53(b) Divisional of Serial No.
10/009,168, Filed December 7, 2001)

THE COMMISSIONER IS AUTHORIZED
TO CHARGE ANY DEFICIENCY IN THE
FEE FOR THIS PAPER TO DEPOSIT
ACCOUNT NO. 23-0975.

CLAIM OF PRIORITY UNDER 35 USC 119

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

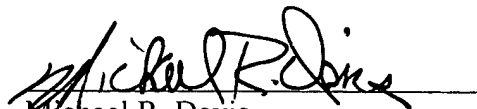
Applicants in the above-entitled application hereby claim the date of priority under the International Convention of Japanese Patent Application No. 11-165165, filed June 11, 1999, as acknowledged in the Declaration of this application.

A certified copy of said Japanese Patent Application was submitted to the PTO as evidenced by Form PCT/IB/304, a copy of which is of record in parent application Serial No. 10/009,168, filed December 7, 2001, and as acknowledged by the Examiner in the parent application.

Respectfully submitted,

Kazumi MATSUSHIGE et al.

By:



Michael R. Davis
Registration No. 25,134
Attorney for Applicants

MRD/pth
Washington, D.C. 20006-1021
Telephone (202) 721-8200
Facsimile (202) 721-8250
January 20, 2004